



SUPER-SEMI



## SUPER-MOSFET

Super Junction Metal Oxide Semiconductor Field Effect Transistor

650V Super Junction Power MOSFET Gen- II  
SS\*65R420S2

Rev. 1.0  
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# SSF65R420S2/SSP65R420S2/SST65R420S2 650V N-Channel Super-Junction MOSFET Gen-II

## Description

SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.

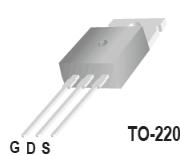
## Features

- Multi-Epi process SJ-FET
- 700V @ $T_J = 150^\circ\text{C}$
- Typ.  $R_{DS(on)} = 0.36\Omega$  (TO-220F)
- Ultra Low Gate Charge (typ.  $Q_g = 19.5\text{nC}$ )
- 100% avalanche tested

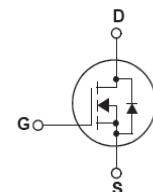
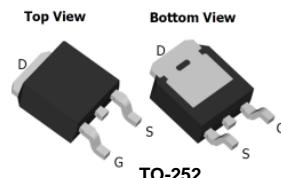
SSF65R420S2



SSP65R420S2



SST65R420S2



## Absolute Maximum Ratings

Symbol	Parameter	SSP_T65R420S2	SSF65R420S2	Unit
$V_{DSS}$	Drain-Source Voltage	650		V
$I_D$	Drain Current - Continuous ( $TC = 25^\circ\text{C}$ )	10.5*		A
	- Continuous ( $TC = 100^\circ\text{C}$ )	6.7*		
$I_{DM}$	Drain Current - Pulsed (Note 1)	42		A
$V_{GSS}$	Gate-Source voltage	$\pm 30$		V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	142		mJ
$I_{AS}$	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_j$ max)	3.1		A
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)	15		V/ns
$dVds/dt$	Drain Source voltage slope ( $V_{ds}=480\text{V}$ )	50		V/ns
$P_D$	Power Dissipation ( $TC = 25^\circ\text{C}$ )	96	31	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		°C
$T_L$	Maximum Lead Temperature for Soldering Purpose, 1/16" from Case for 10 Seconds	260		°C

\* Drain current limited by maximum junction temperature. Maximum duty cycle D=0.75.

## Thermal Characteristics

Symbol	Parameter	SSP_T65R420S2	SSF65R420S2	Unit
$R_{eJC}$	Thermal Resistance, Junction-to-Case	1.3	4.0	°C/W
$R_{eCS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	-	°C/W
$R_{eJA}$	Thermal Resistance, Junction-to-Ambient	62	80	°C/W



# Electrical Characteristics TC = 25°C unless otherwise noted

SSF65R420S2/SSP65R420S2/SST65R420S2 650V N-Channel Super-Junction MOSFET Gen-II

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BVdss	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA, T <sub>J</sub> = 25°C	650	-	-	V
		V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA, T <sub>J</sub> = 150°C	-	700	-	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250µA, Referenced to 25°C	-	0.6	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>D</sub> S = 650V, V <sub>G</sub> S = 0V -T <sub>C</sub> = 125°C	-	-	100	µA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>G</sub> S = 30V, V <sub>D</sub> S = 0V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>G</sub> S = -30V, V <sub>D</sub> S = 0V	-	-	-100	nA
<b>On Characteristics</b>						
V <sub>G</sub> (th)	Gate Threshold Voltage	V <sub>D</sub> S = V <sub>G</sub> S, I <sub>D</sub> = 250µA	2.0	3.0	4.0	V
R <sub>D</sub> S(on)	Static Drain-Source On-Resistance	V <sub>G</sub> S = 10V, I <sub>D</sub> = 5.5A (TO-220/TO-220F)	-	0.36	0.42	Ω
		V <sub>G</sub> S = 10V, I <sub>D</sub> = 5.5A (TO-252)	-	0.37	0.43	Ω
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>D</sub> S = 100V, V <sub>G</sub> S = 0V, f = 1.0MHz	-	700	-	pF
C <sub>oss</sub>	Output Capacitance		-	29	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	0.4	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>D</sub> S = 400V, I <sub>D</sub> = 11A, V <sub>G</sub> S = 10V (Note 4)	-	19.5	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	4.5	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	8.5	-	nC
R <sub>g</sub>	Gate resistance	f=1 MHz, open drain	-	8.2	-	Ω
<b>Switching Characteristics</b>						
t <sub>d</sub> (on)	Turn-On Delay Time	V <sub>D</sub> S = 400V, I <sub>D</sub> = 5.5A R <sub>G</sub> = 10Ω, V <sub>G</sub> S = 10V (Note 4)	-	12.2	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	22.5	-	ns
t <sub>d</sub> (off)	Turn-Off Delay Time		-	40	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	19.5	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current	V <sub>G</sub> S = 0V, I <sub>s</sub> = 11A	-	-	10.5	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	42	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>G</sub> S = 0V, I <sub>s</sub> = 11A	-	0.9	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>G</sub> S = 0V, V <sub>D</sub> S = 400V, I <sub>s</sub> = 5.5A, dI/dt = 100A/µs	-	240	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	1.74	-	µC
I <sub>rrm</sub>	Peak Reverse Recovery Current		-	14.5	-	A

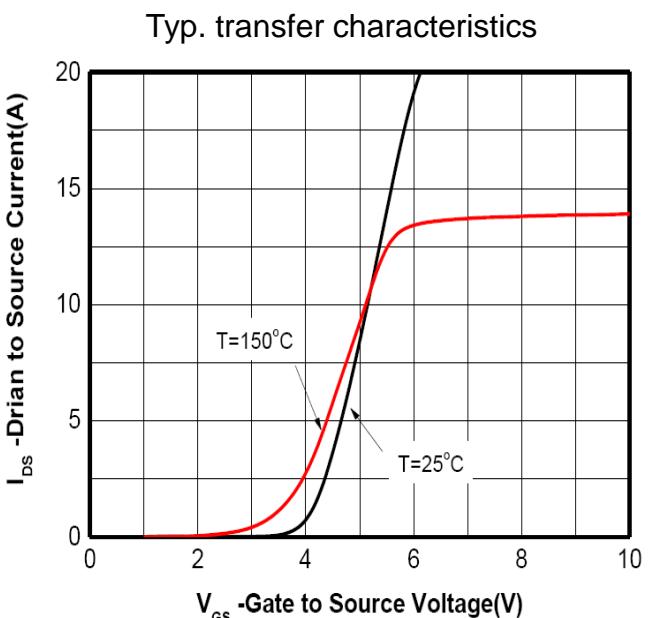
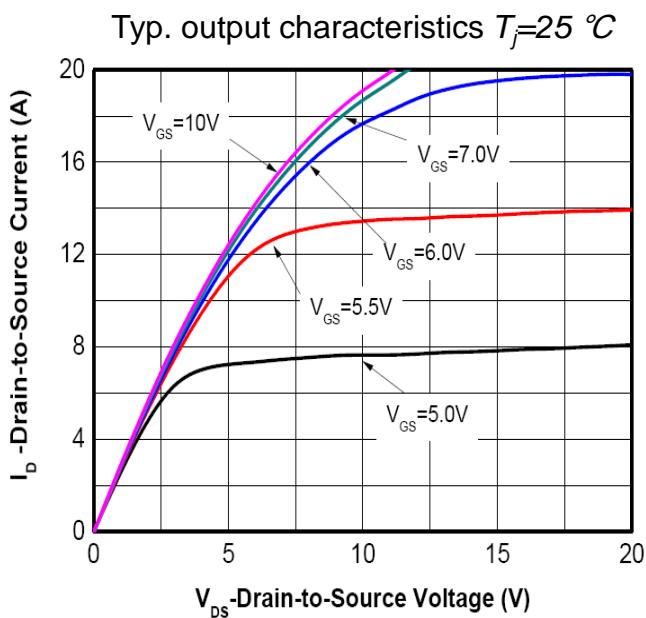
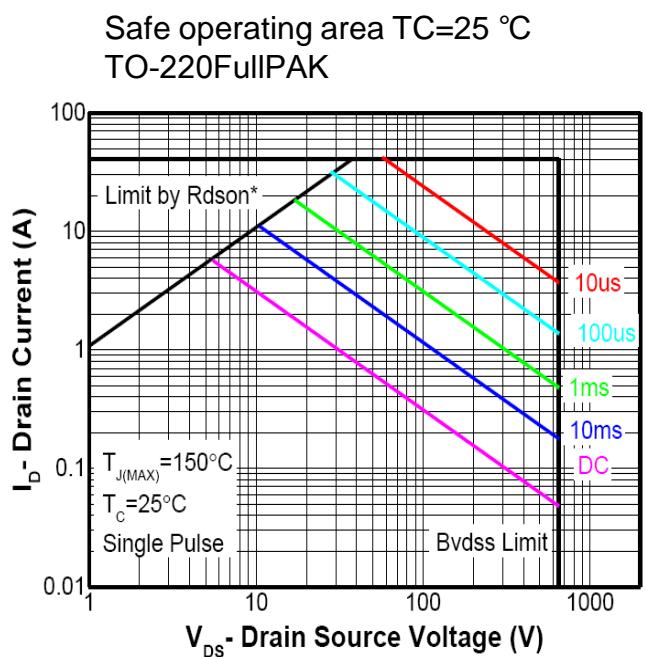
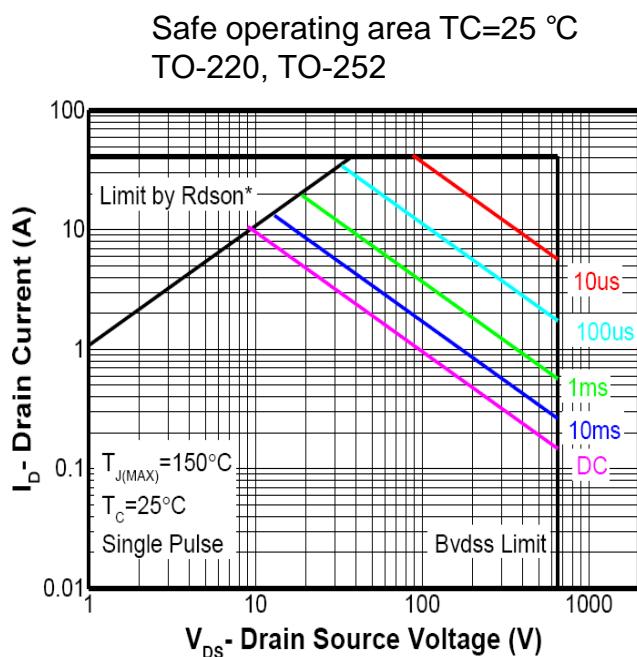
#### NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>D</sub>=I<sub>AS</sub>, V<sub>DD</sub>=50V, Starting T<sub>J</sub>=25 °C
3. I<sub>SD</sub>≤I<sub>D</sub>, di/dt ≤ 200A/us, V<sub>DD</sub>≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25 °C
4. Essentially Independent of Operating Temperature Typical Characteristics



## Typical Performance Characteristics

SSF65R420S2/SSP65R420S2/SST65R420S2 65V N-Channel Super-Junction MOSFET Gen-II

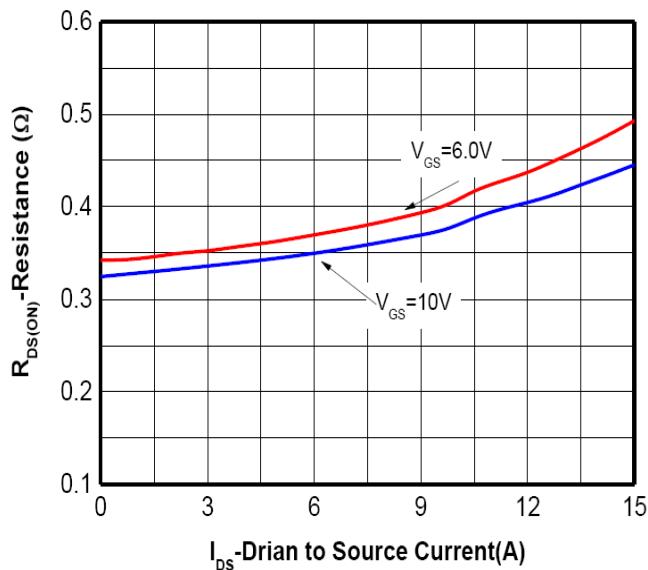




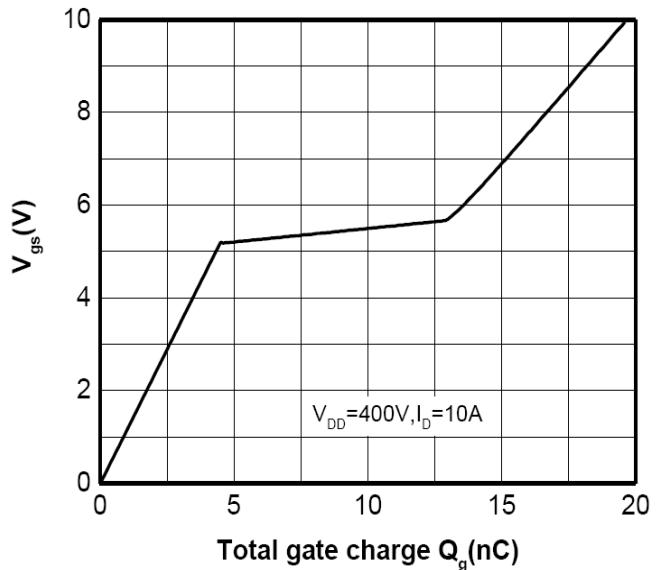
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## Typical Performance Characteristics

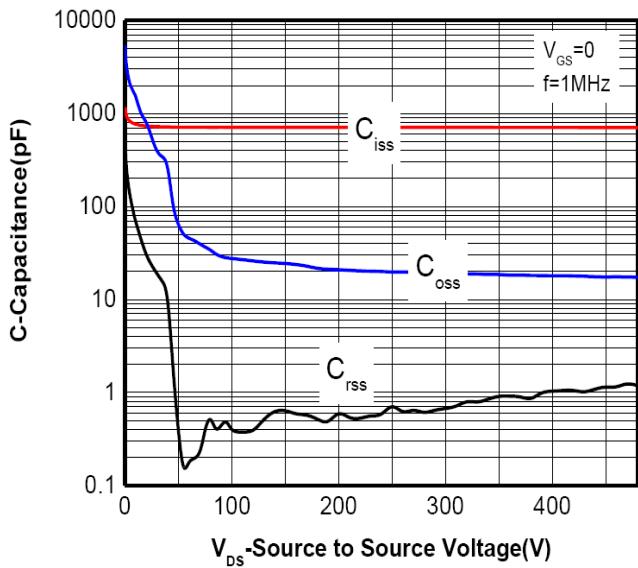
Typ. drain-source on-state resistance  
TO-220/TO-220F



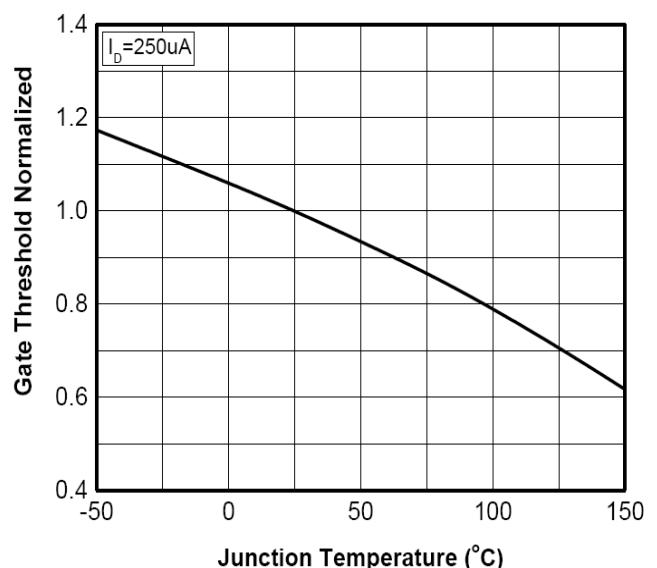
Typ. gate charge characteristics



Typ. capacitances

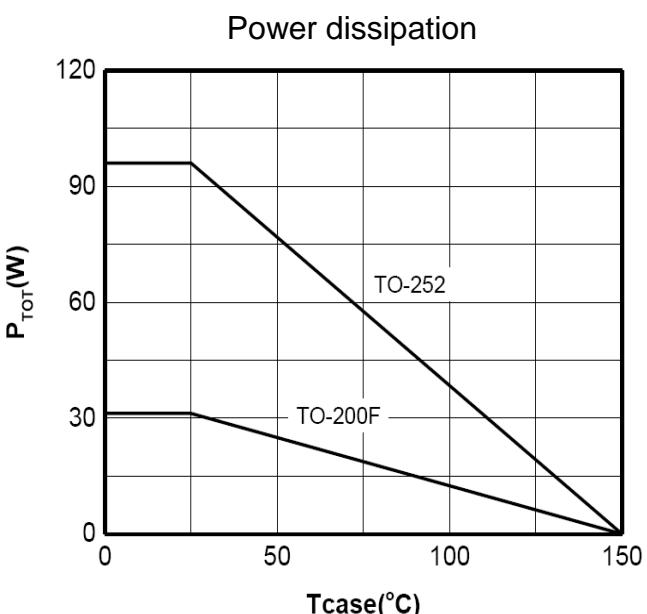
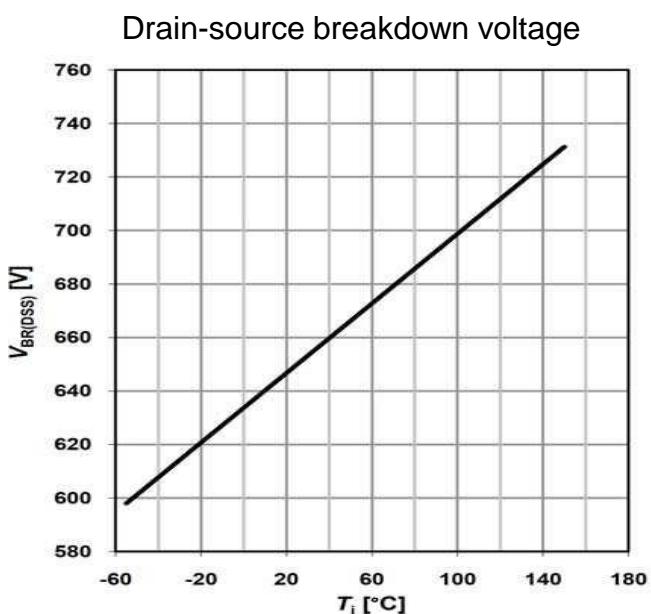
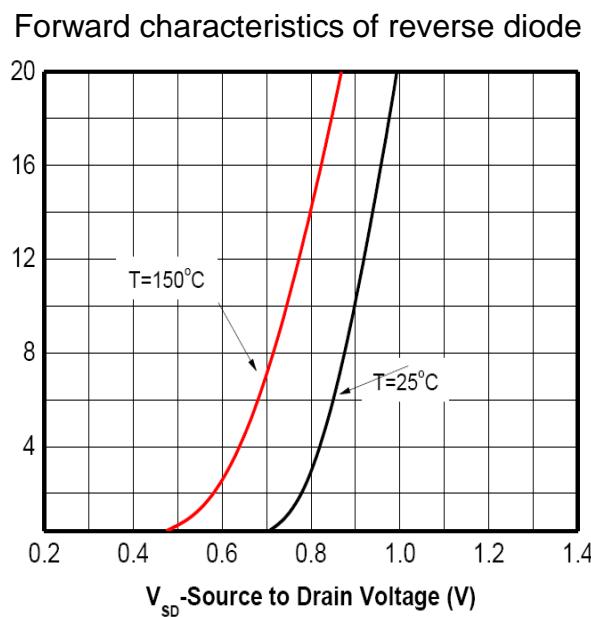
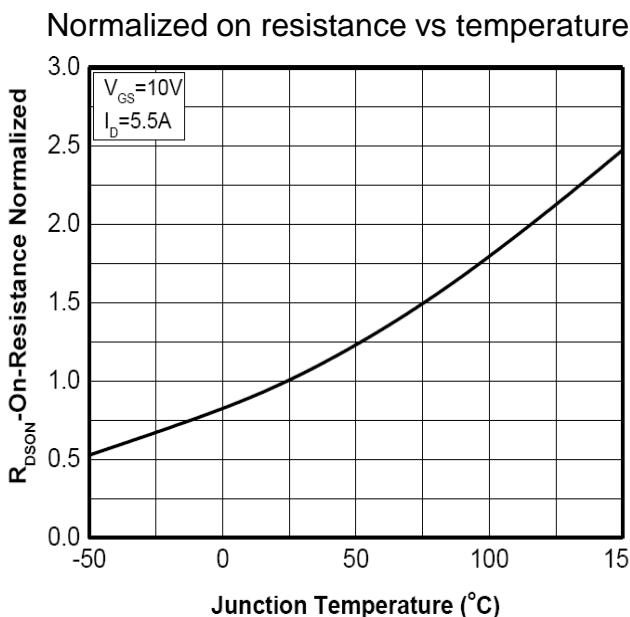


Normalized  $V_{GS(th)}$  characteristics





## Typical Performance Characteristics

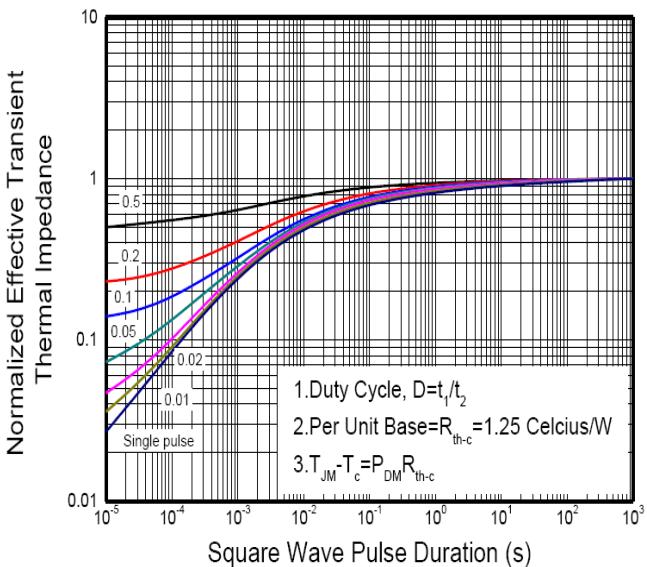




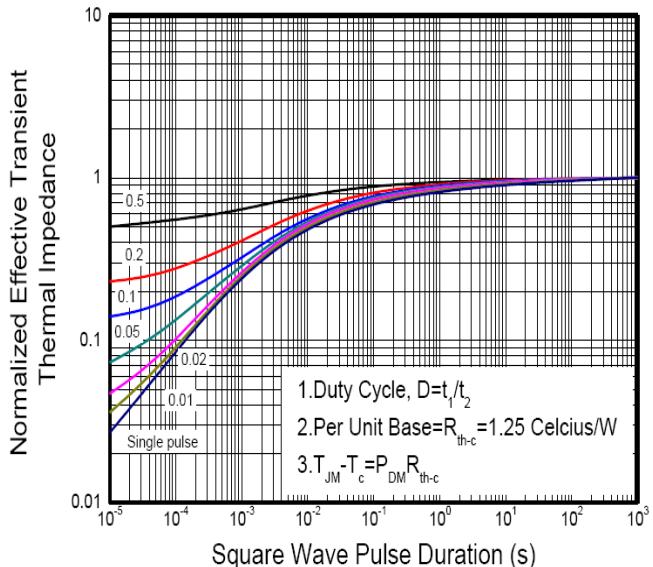
## Typical Performance Characteristics

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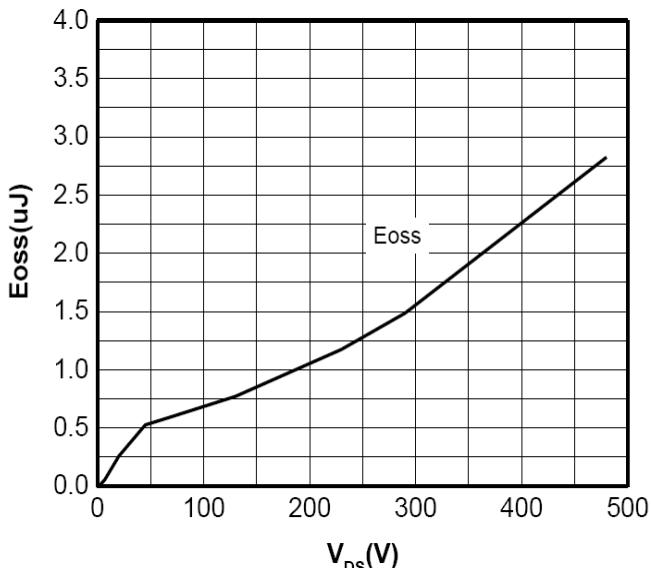
Max. transient thermal impedance  
TO-220, TO-252



Max. transient thermal impedance  
TO-220FullPAK



Cross stored energy





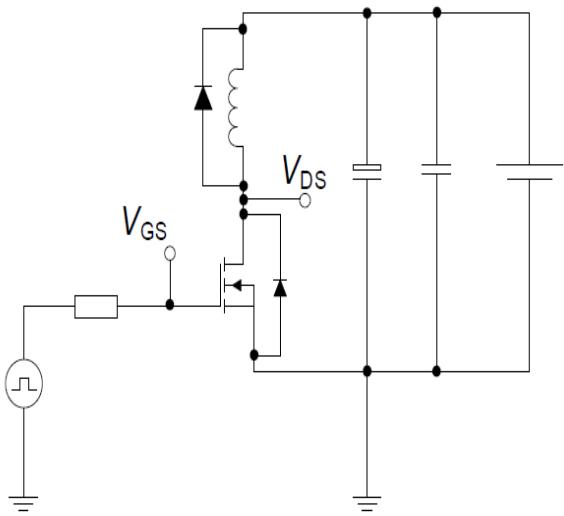
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## Test circuits

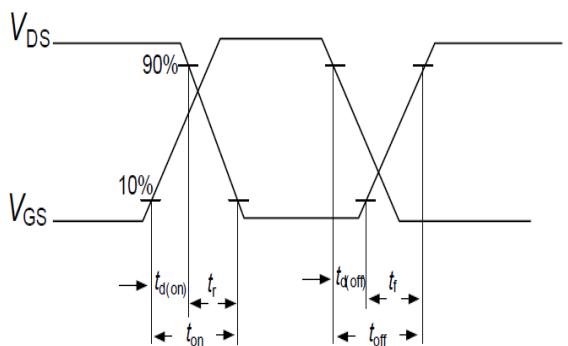
SSF65R420S2/SSP65R420S2/SST65R420S2 650V N-Channel Super-Junction MOSFET Gen-II

### Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

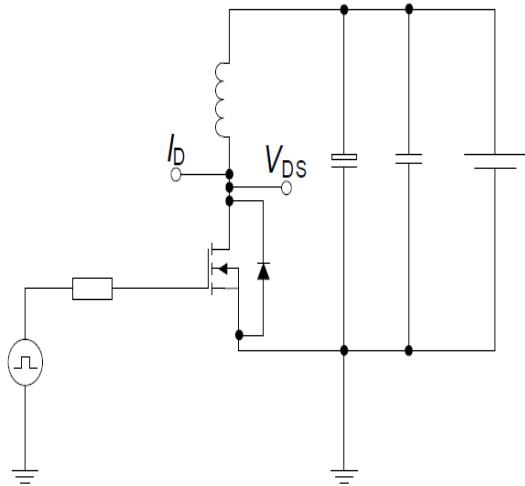


Switching time waveform

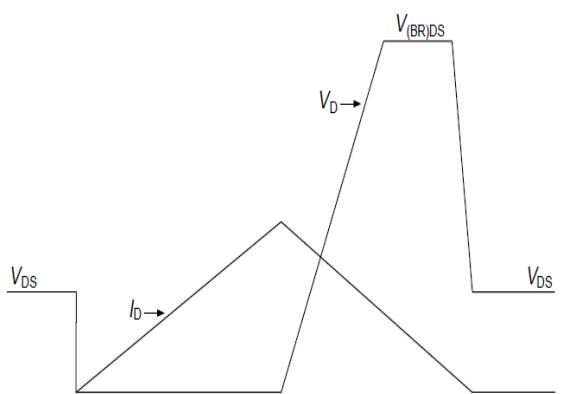


### Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit



Unclamped inductive waveform





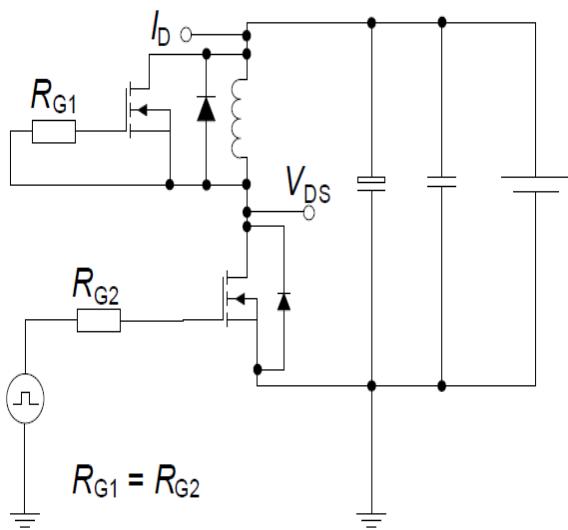
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## Test circuits

SSF65R420S2/SSP65R420S2/SST65R420S2 650V N-Channel Super-Junction MOSFET Gen-II

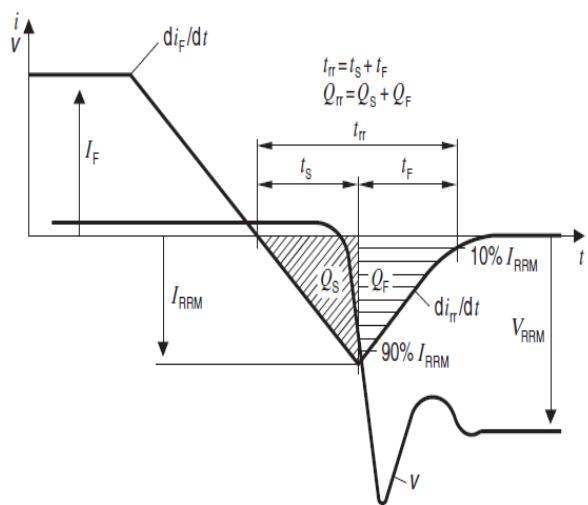
### Test circuit and waveform for diode characteristics

Test circuit for diode characteristics



$$R_{G1} = R_{G2}$$

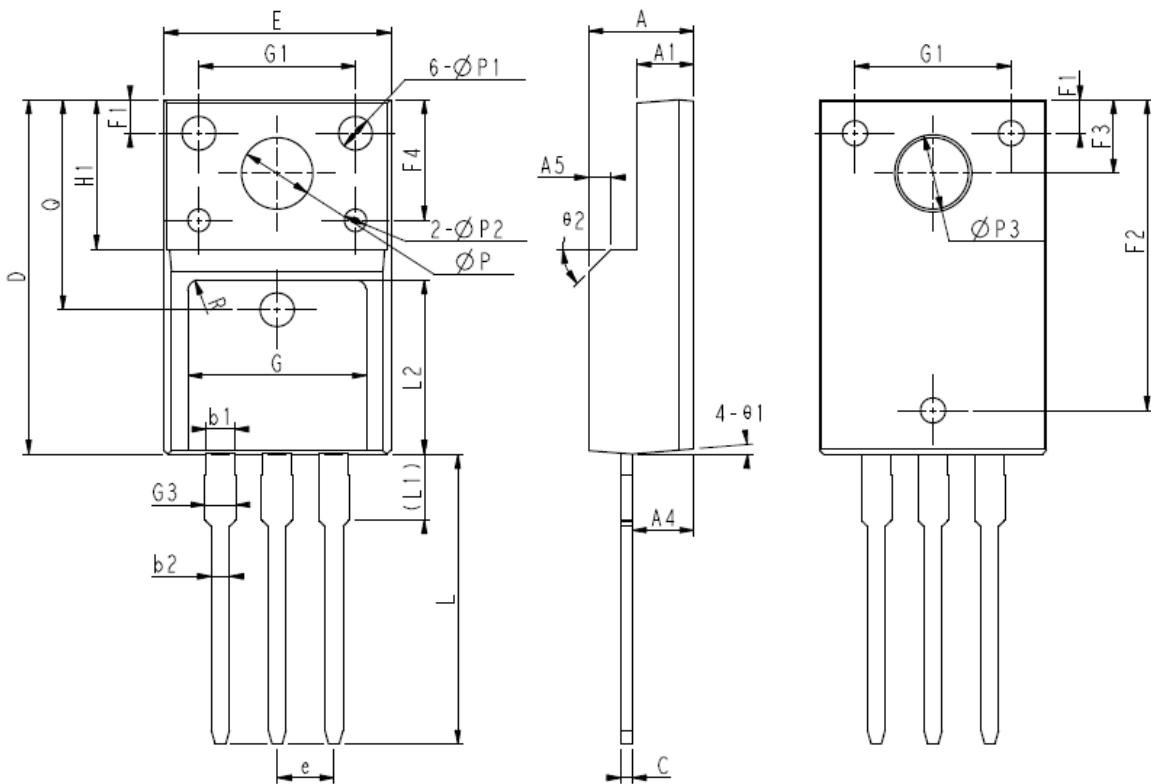
Diode recovery waveform



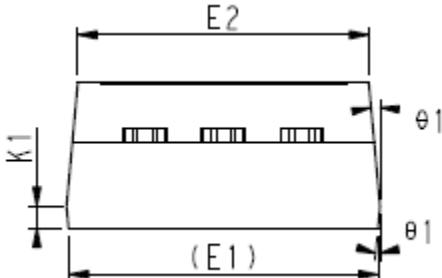


## Package Outline

TO-220 Full PAK



COMMON DIMENSIONS

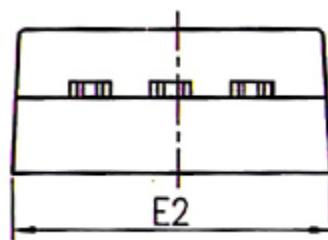
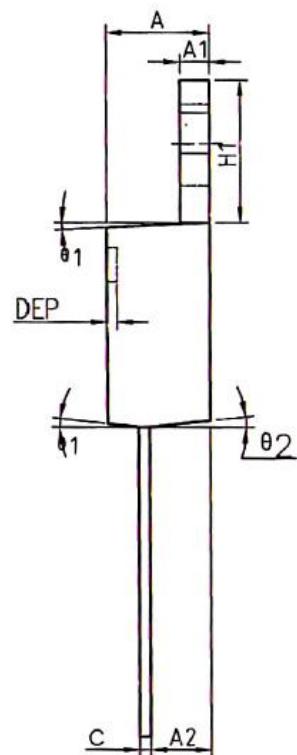
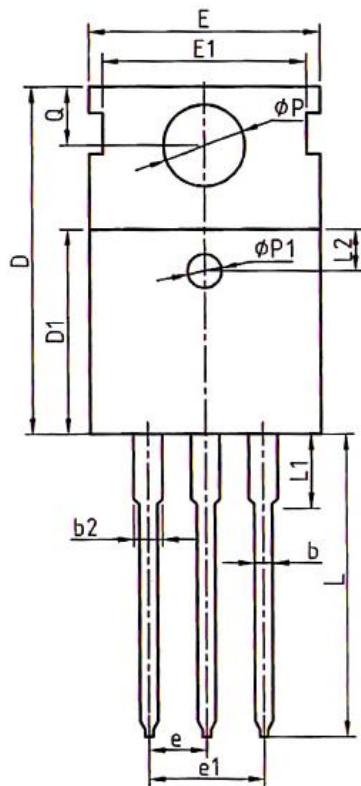


SYMBOL	MM		
	MIN	NOM	MAX
E	10.00	10.16	10.32
E1	9.94	10.04	10.14
E2	9.36	9.46	9.56
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.66	2.76	2.86
A5		1.00REF	
c	0.45	0.50	0.60
D	15.67	15.87	16.07
Q		9.40REF	
H1		6.70REF	
e		2.54BSC	
ΦP		3.18REF	
L	12.78	12.98	13.18
L1	2.83	2.93	3.03
L2	7.70	7.80	7.90
ΦP1	1.40	1.50	1.60
ΦP2	0.95	1.00	1.05
ΦP3		3.45REF	
θ1	3°	5°	7°
θ2	-	45°	-
F1	1.00	1.50	2.00
F2	13.80	13.90	14.00
F3	3.20	3.30	3.40
F4	5.30	5.40	5.50
G	7.80	8.00	8.20
G1	6.90	7.00	7.10
G3	1.25	1.35	1.45
b1	1.23	1.28	1.38
b2	0.75	0.80	0.90
K1	0.65	0.70	0.75
R		0.50REF	



## Package Outline

TO-220



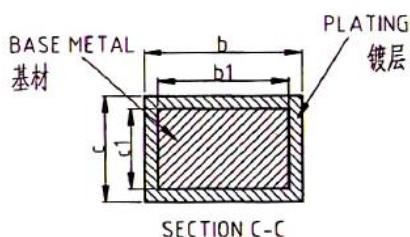
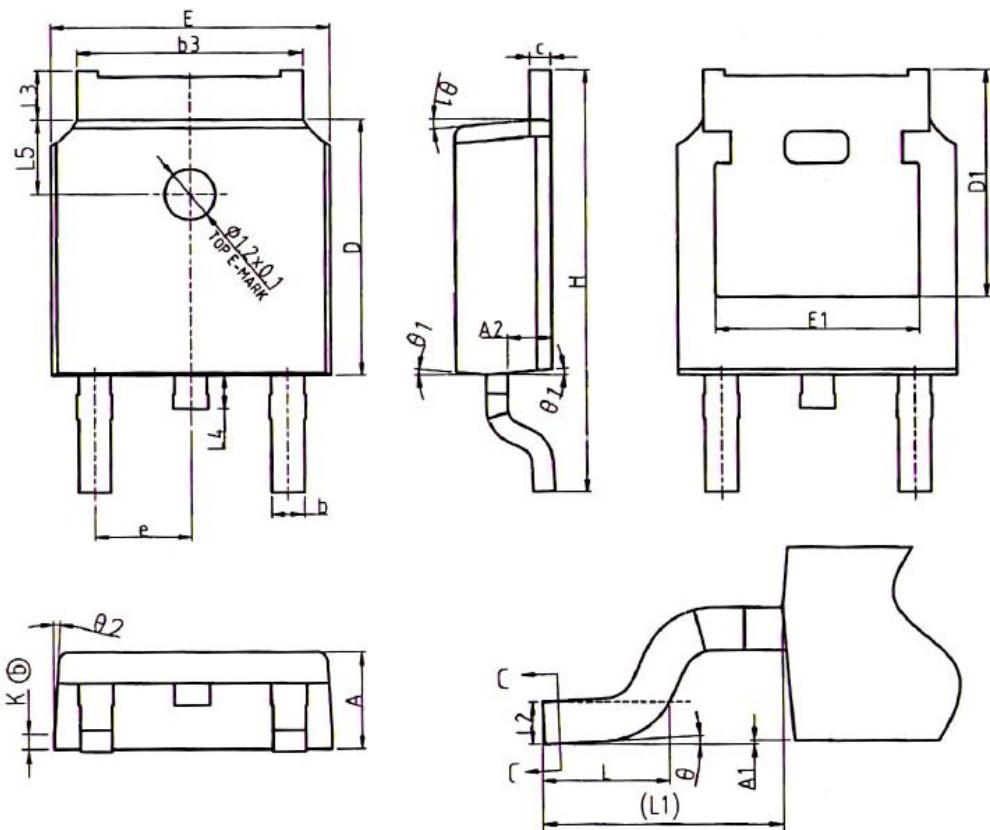
COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	4.40	4.57	4.70
A1	1.27	1.30	1.37
A2	2.35	2.40	2.50
b	0.77	0.80	0.90
b2	1.17	1.27	1.36
c	0.48	0.50	0.56
D	15.40	15.60	15.80
D1	9.00	9.10	9.20
DEP	0.05	0.10	0.20
E	9.80	10.00	10.20
E1	-	8.70	-
E2	9.80	10.00	10.20
φP1	1.40	1.50	1.60
e	2.54BSC		
e1	5.08BSC		
H1	6.40	6.50	6.60
L	12.75	13.50	13.65
L1	-	3.10	3.30
L2	2.50REF		
φP	3.50	3.60	3.63
Q	2.73	2.80	2.87
θ1	5°	7°	9°
θ2	1°	3°	5°
θ3	1°	3°	5°



## Package Outline

TO-252



### COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.97	1.07	1.17
b	0.72	0.78	0.85
b1	0.71	0.76	0.81
b3	5.23	5.33	5.46
c	0.47	0.53	0.58
c1	0.46	0.51	0.56
D	6.00	6.10	6.20
D1	5.30REF		
E	6.50	6.60	6.70
E1	4.70	4.83	4.92
e	2.286BSC		
H	9.90	10.10	10.30
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.51BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	1.70	1.80	1.90
θ	0°	-	8°
θ1	5°	7°	9°
θ2	5°	7°	9°
K	0.40REF		



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